

## Zhen Ding Technology Holding (4958 TT)

## **Investor Presentation**

April 2024



## **Safe Harbor Notice**

- Zhen Ding Technology Holding's statements of its current expectations are forward looking statements subject to significant risks and uncertainties and actual results may differ materially from those contained in the forward-looking statements.
- Except as required by law, we undertake no obligation to update any forward-looking statement, whether as a result of new information, future events, or otherwise.



## Zhen Ding (ZDT) At a Glance



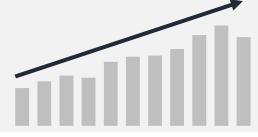
Located in Mainland China, Taiwan, India

#### NT\$151.4 Bn

Revenue in 2023 (-11.6% YoY)



2013-2023 Revenue CAGR



1,648

Accumulated Valid Patents

#### 3,528

Patents Applied (as of Dec. 2023)



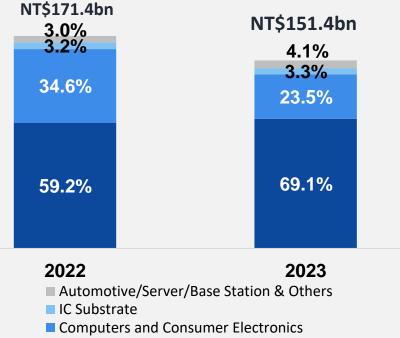
## NT\$95.2 Bn 14.7%

Market Cap as of

Feb. 2024

10Y Average ROE

#### **Revenue Breakdown – By Applications**



Mobile Communication



# Why Invest in ZDT?

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#### World's largest PCB manufacturer with stable long-term growth:

ZDT has become the world's largest PCB manufacturer since 2017. We have achieved a 9% revenue CAGR during 2013-2023.

#### Leverage One ZDT synergies to further widen the market share gap:

With One ZDT as the core strategy, we will continue to drive steady growth by leveraging the synergies from one-stop shopping. Our global PCB market share was 7.0% in 2023, and we aim to increase it to 10% by 2030.

#### **Aggressive expansion in IC substrate:**

We plan to invest NT\$60 billion capex for IC substrates in 2022-2027. We strive to become one of the top five global IC substrate suppliers by 2030.

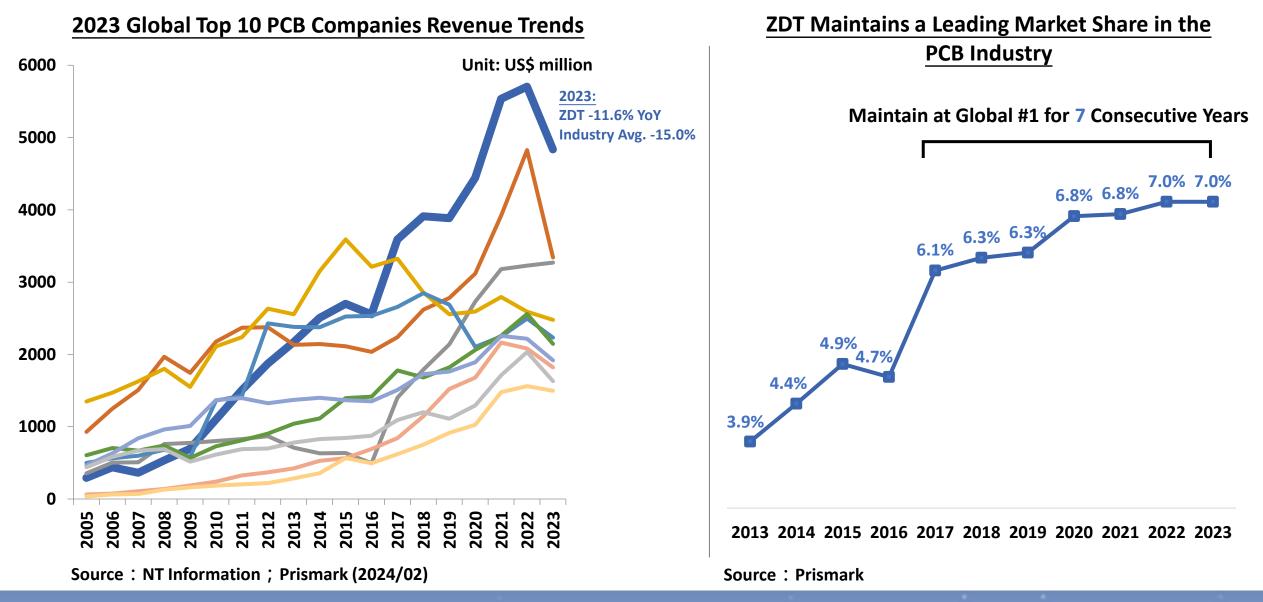
#### Global manufacturing footprint:

In addition to the three major manufacturing campuses in Mainland China, we also own manufacturing plants in Taiwan and India, and are constructing a new plant in Thailand. In the future, we will keep expand our global manufacturing bases to serve diversified customer needs.



## World's Largest PCB Manufacturer with Stable Long-term Growth

#### 臻鼎科技控版 Zhen Ding Tech. Holding ZDT Outperforms Industry Average, Maintaining #1 Position





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## **2023 Review and Outlook**

#### 2023 revenue declined by 11.6% YoY, in line with our expectation, and better than the industry average decline of 15%:

In 2023, due to the weak global demand for consumer electronics, ZDT's revenue declined for the first time since 2017 but was better than the industry average decline. Thanks to the "One ZDT" strategy, our product mix became more diversified, and our revenue for automotive/server/base station increased by 19% YoY in 2023.

## 2024 revenue is expected to grow moderately, and the structural adjustments of the product mix will continue. The revenue momentum of IC substrates, servers, and automotive applications is on the rise:

Our operation has bottomed out in 2023, and we will continue to optimize our product mix in 2024. We expect consumer electronics will recover moderately, and for other diversified applications, including IC substrates, servers and automotive to grow by double digits. We expect revenue growth to accelerate in 2025.

## The introduction of more AI features into edge devices will drive increasing demand for high-end PCBs/IC substrates, and ZDT will greatly benefit from this trend:

Under the Edge AI trend, devices such as smartphones and PCs/notebooks will gradually incorporate various AI applications, driving the demand for high-end PCBs/IC substrates with fine lines and high layer counts. We are a global leading manufacturer of high-end PCBs/IC substrates and is expected to benefit from the Edge AI trend.

#### The new fab in Thailand has started construction in December 2023, strengthening our global manufacturing footprint:

The Thailand fab commenced construction in December last year, with an initial investment of US\$250 million. Currently, the construction is progressing according to plan, with the goal of entering trial production in 1H25 and mass production in a small scale in 2H25. It will be our key manufacturing base in Southeast Asia.

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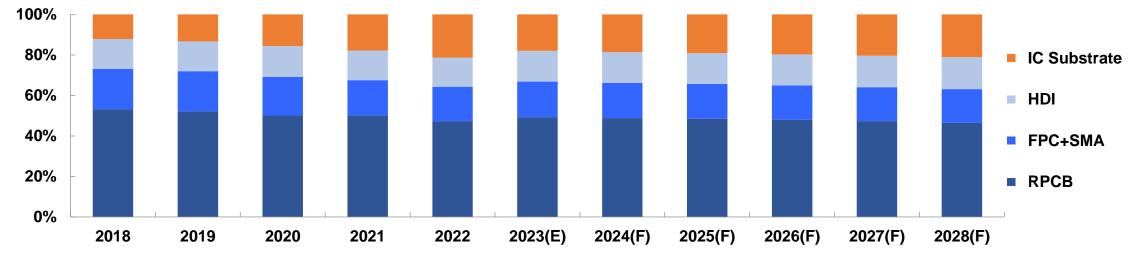
## Leverage One ZDT Synergies to Further Widen the Market Share Gap

#### Aim to Reach 10% Global PCB Market Share by 2030

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## **All PCB Segments to Resume Growth in 2024**

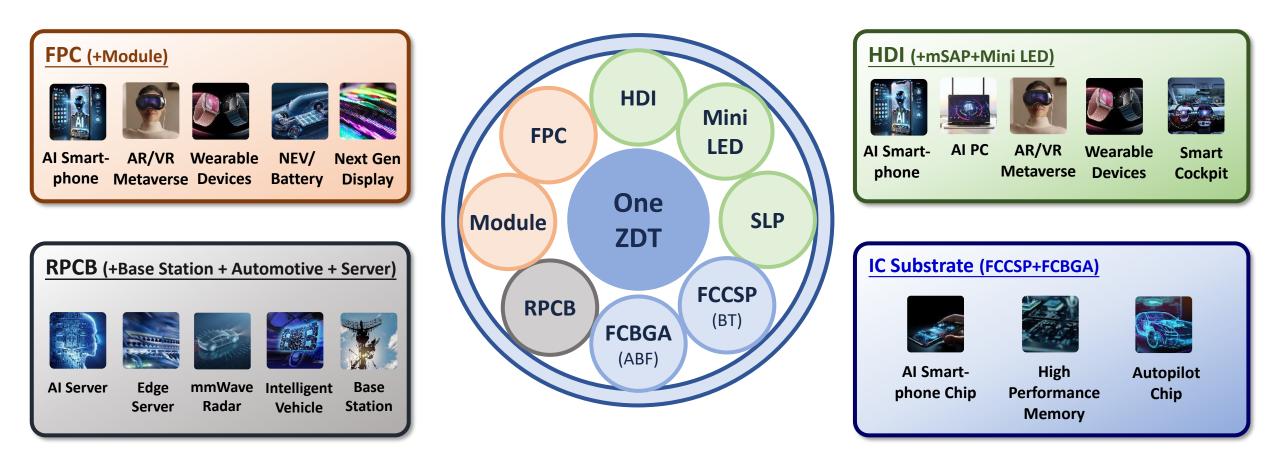


Product	Item	2018	2019	2020	2021	2022	2023(E)	2024(F)	2025(F)	2026(F)	2027(F)	2028(F)	2023-2028 CAGR	
DDCD	Value	33,225	31,969	32,674	40,641	38,720	34,292	35,659	37,554	39,240	40,724	42,005	4.1%	
RPCB	%	53.2%	52.1%	50.1%	50.2%	47.4%	49.3%	48.9%	48.5%	48.0%	47.3%	46.5%		
	Value	12,395	12,195	12,483	14,058	13,842	12,191	12,649	13,225	13,828	14,458	15,117	4.4%	
FPC+SMA	%	19.9%	19.9%	19.1%	17.4%	16.9%	17.5%	17.3%	17.1%	16.9%	16.8%	16.7%	4.470	
	Value	9,222	9,008	9,874	11,811	11,763	10,536	11,095	11,806	12,563	13,369	14,226	6.2%	
HDI	%	14.8%	14.7%	15.1%	14.6%	14.4%	15.2%	15.2%	15.3%	15.4%	15.5%	15.7%		
IC	Value	7,554	8,139	10,188	14,410	17,415	12,498	13,568	14,772	16,083	17,511	19,065	0.00/	
Substrate	%	12.1%	13.3%	15.6%	17.8%	21.3%	18.0%	18.6%	19.1%	19.7%	20.3%	21.1%	8.8%	
1	Total	62,396	61,311	65,219	80,920	81,740	69,517	72,971	77,358	81,715	86,062	90,413	5.4%	
YoY C	hange (%)	6.0%	-1.7%	6.4%	24.1%	1.0%	-15.0%	5.0%	6.0%	5.6%	5.3%	5.1%		

Source : Prismark(2024/2) ; 2025~27's data is calculated based on Prismark's estimation



## **One ZDT : One Stop Shopping Synergies**



The diversification of AI applications will increase design complexity for PCBs, driving growing demand for IC substrates, high-end HDI, and FPC.

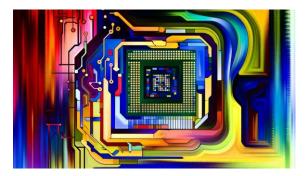
## ZDT: Strong Competitive Advantage under the Edge AI Trend

**Edge Al** 

Zhen Ding Tech. Holding

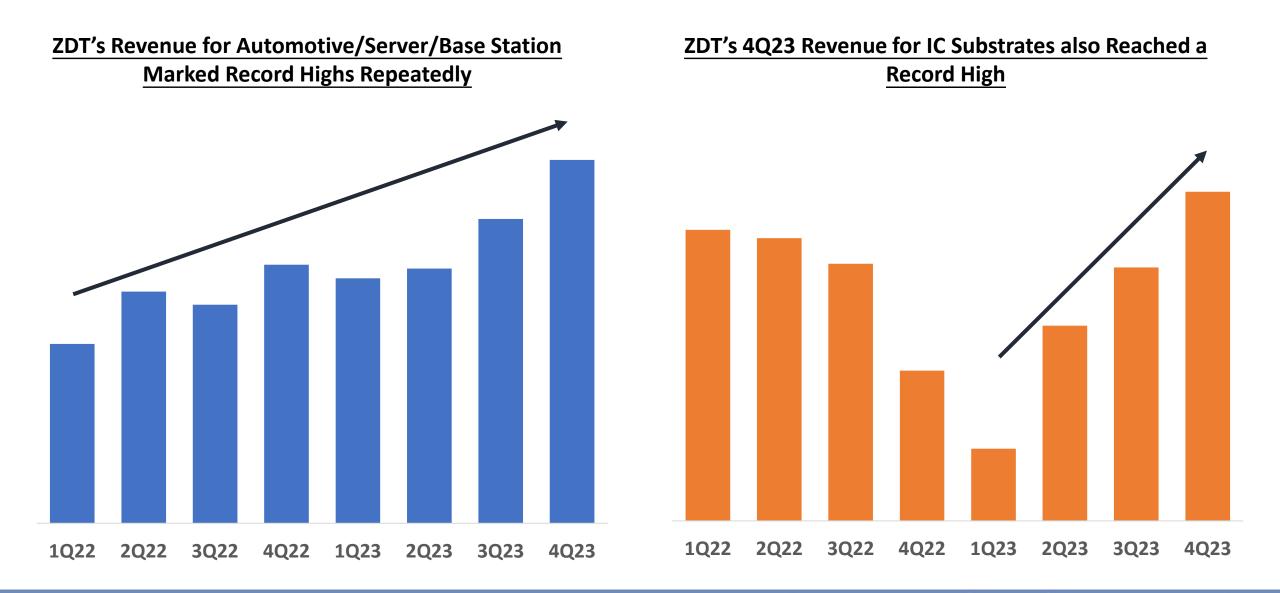
Execute various Al applications, including realtime translation, voice note assistants and image editing assistants.

The human-machine interface is evolving towards diversification, including sound, gestures and eye movements. The design of PCB and IC substrate become more complex, with growing demand for fine lines and high layer counts products.



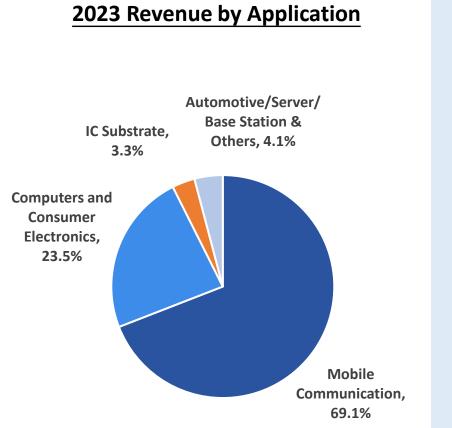
Zhen Ding is a leading manufacturer of high-end PCB and IC substrates. We have a strong competitive advantage under the Edge AI trend.

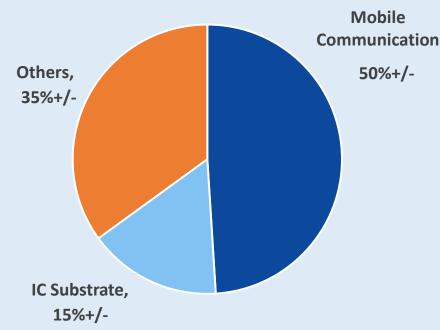
## 暴鼎科技控股 Solid Growth Momentum from Diversified Applications



#### 臻鼎科技控版 Zhen Ding Tech. Holding Aim to Reach 10% Global PCB Market Share by 2030

**2027 Target Revenue by Application** 





# Aim to Reach 10% Global Market Share by 2030

#### 2023 2024 2025 2026 2027 2028 2029 2030



## **Aggressive Expansion in IC Substrate**

#### Aim to Become One of the Top Five in the World by 2030



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## **IC Substrate Business Update**

- IC substrate revenue reached a record high in 4Q23. BT substrates continue to recover, and the average utilization rate in 2024 is expected to exceed 80%. The BT business may turn profitable this year:
  - The utilization rate of BT substrates in 4Q23 has recovered to over 70%, ahead of previous expectations. We expect the utilization rate will further increase this year, and the BT business may turn profitable.
- ABF substrates have obtained customer qualifications and entered mass production, with revenue and utilization rate expected to increase quarter by quarter this year:
  - In terms of ABF substrates, the demand for AI and automotive is strong. We are actively expanding our presence in these two major areas, and we have obtained customer qualifications and entered mass production. We expect that ABF revenue and capacity utilization rates will increase quarter by quarter this year.

#### We have a distinct advantage in fulfilling international customers' "China for China" demand:

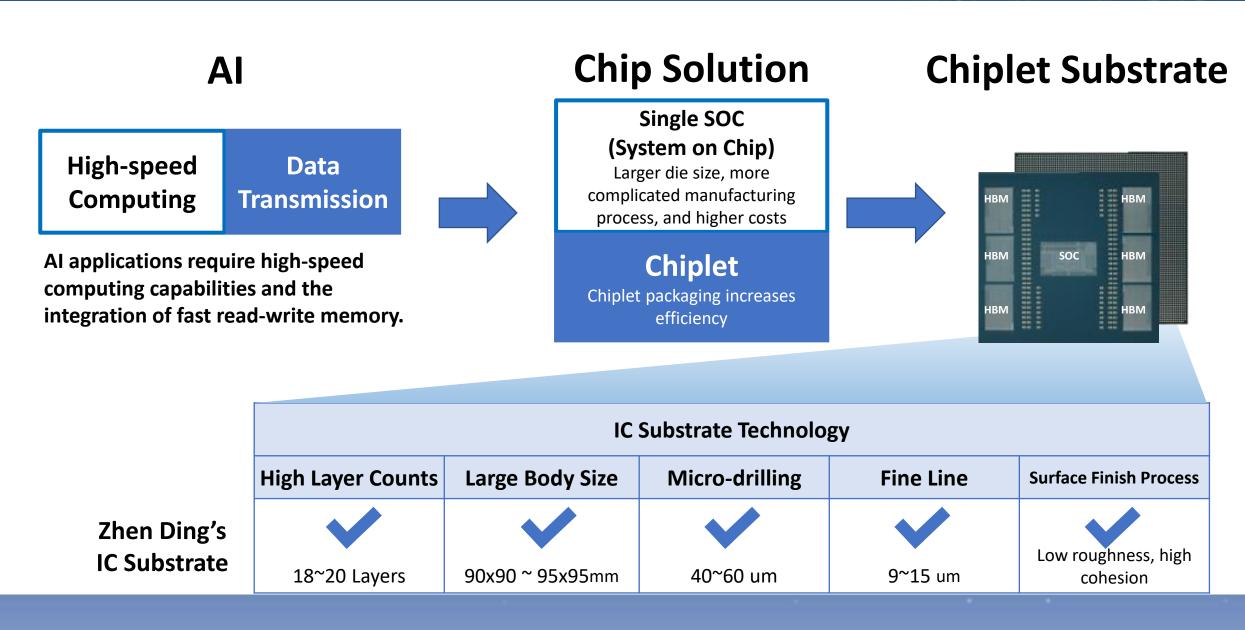
 To increase market share, international customers need to gradually deploy local production capacity in the mainland China market. We have the most advanced IC substrate fabs in mainland China, which can fulfill international customers' "China for China" demand. This is our distinct advantage in the IC substrate industry.

#### Focusing on developing high density and fine line products:

- For ABF substrates, we have collaborated with customers to develop high-end substrates for Chiplet. Currently, we are shipping products with 18-20 layers and a maximum body size of 92mm x 92mm to customers. Our yield has been on par with Tier 1 ABF substrate suppliers. We have shipped 102mm x 102mm body size to customers for testing.
- For BT substrates, we can offer fine-line 6/8um Embedded Trace Substrate (ETS), and the yield is also on par with Tier 1 players.



## **AI Application – Chiplet Substrate**





## Automotive IC Substrate

Intelligence	DCU	Chip	Packaging	ZDT's IC Substrate		
	<ul> <li>Autopilot DCU</li> <li>Cockpit DCU</li> <li>Sensor</li> <li>mmWave Radar</li> <li>Laser Radar</li> <li>Camera</li> </ul>	Autopilot AI Chip Smart Cockpit Chip DCU ChipCMOS Storage Chip ADAS ChipImage: Chip chip chip chip chip chip chip chip c	FCBGA CSP	FCBGA		
Connectivity	<ul> <li>Communication Module</li> <li>Remote Communication Box</li> <li>Internet of Vehicle</li> <li>5G Module</li> </ul>	Smart Cockpit Chip	FCCSP	17x17~75x75mm <b>FCCSP</b> 2~4L 7x7~21x21mm		
Information	<ul> <li>Display System</li> <li>HUD</li> <li>AR/VR</li> <li>NFC</li> </ul>	Smart Cockpit Chip Storage Chip	FCCSP CSP	WBCSP		
		•		2~4L		

7x7~27x27mm



## **IC Substrate Capacity Expansion Plan**

			20	23			20	24		2025			20	2026			
		1Q	2Q	3Q	4Q	1Q	2Q	3Q	4Q	1Q	2Q	3Q	4Q	1Q	2Q	3Q	4Q
			Instal	lation													
SZ ABF	Fab 1 (Mid to high- end products)	Sa	ample ce	ertificati	on												
Substrate Plant (Two Fabs'				Mass	product	ion, tar	get yield	: compa	rable to	tier 1 p	eers					rget yie er 1 pee	
floor area in total:	<b>Fab 2</b> (High end products)												Inst	allation			
170,000 m²)												Sample certification					
														1	Mass pro	oductior	
QHD BT Substrate Plant	Fab 1	Industry Leading Quality															
(Two Fab's floor area in total: 60,000 m <sup>2</sup> )	Fab 2	Mas	ss Produ	ction		Utilization at 80%+				Industry Leadi				ding Qu	ality		



IC Substrate Goals









#### **IC Substrate Capex:**

Plan to invest NT\$60bn from 2022~2027

#### **IC Substrate Revenue:**

2023~2027 Revenue CAGR >50%

#### **IC Substrate Revenue:**

Account for 15 %+/- of company's consolidated revenue in 2027

#### IC Substrate Market Share:

Aim to become one of the global top 5 companies in the IC substrate market in 2030



## **Global Manufacturing Footprint**



## Six Major Global Manufacturing Campuses



#### 臻鼎科技控版 Zhen Ding Tech. Holding Global Manufacturing Footprint with New Capacity Rolling Out

#### Kaohsiung Luzhu Science Park: FPC and Advanced Module Production Line

#### Thailand Prachinburi Park (Phase 1) : High-end RPCB/HDI



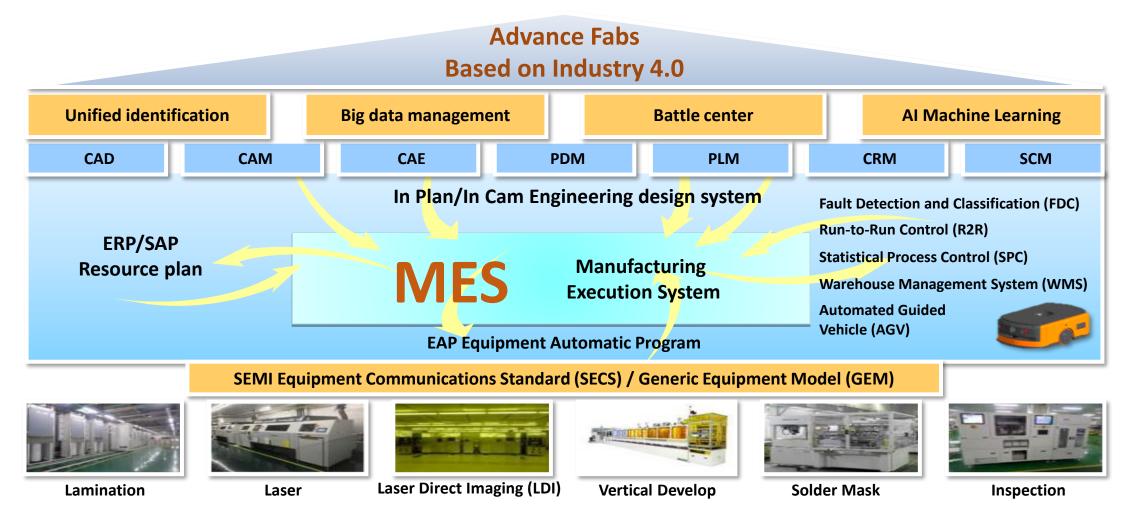
- Plan to enter mass production in 2H24.
- It will be the most advanced FPC fab. ZDT will collaborate with its customers to develop high-end new products.



manufacturing site in

Southeast Asia.

#### 藤鼎科技控版 Find Ding Tech. Holding Introduce Smart Manufacturing into Each Plant Step by Step



Under the One ZDT strategy, we have been introducing smart manufacturing into each plant step by step. Currently, Huai'an Park 3 is the 9th smart fab. These fabs have significant improvements in yields and efficiency.



## **Commitment to EPS + ESG Blueprint**





## **EPS + ESG – Improvement of ESG Ratings**

#### **Corporate Governance Evaluation Ranking**

Ranked between 6% to 20% in the 2023 Corporate Governance Evaluation for listed companies and **re-selected for inclusion in the TWSE Corporate Governance 100 Index.** 

#### **S&P Global ESG Rating**

In 2023, Zhen Ding's S&P ESG Score improved to 73 and was selected as the only PCB company in the S&P Global Sustainability Yearbook for the second consecutive year.

#### Sustainalytics ESG Risk Rating

Zhen Ding's 2023 Sustainalytics ESG Risk Ratings improved from 17.8 to 15.6, classified as **low risk.** 

#### ► ISS ESG Rating

ISS has upgraded Zhen Ding's ESG Rating from "C" to "C+," granting Zhen Ding **"Prime" status.** 

#### ► CDP

In 2023, Zhen Ding received a 'B' rating from CDP for climate change, marking a one-notch improvement from last year. Additionally, we achieved an **'A-' leadership** rating for water security, also advancing by one notch compared to the previous year.

#### **FTSE Russell ESG Rating**

Zhen Ding's FTSE Russell ESG Rating reached 4.3 (out of 5) and ranked in the **4th place among all listed companies in Taiwan.** 



## **Financial Summary**





## **4Q23 Financial Results**

				(Unit: NT\$ million, unless otherwise stated)			
_	4Q23	3Q23	4Q22	QoQ (%)	YoY (%)		
Revenue	54,396	41,919	52,902	29.8%	2.8%		
Gross Profit	11,679	8,583	13,913	36.1%	-16.1%		
Gross Margin	21.5%	20.5%	26.3%	+1.0ppts	-4.8ppts		
Operating Expense	5,424	5,008	5,219	8.3%	3.9%		
Operating Profit	6,254	3,575	8,694	74.9%	-28.1%		
Operating Margin	11.5%	8.5%	16.4%	+3.0ppts	-4.9ppts		
Non-Operating Income/Expense	(409)	222	(973)				
Net Income	5,070	3,349	6,857	51.4%	-26.1%		
Net Margin	9.3%	8.0%	13.0%	+1.3ppts	-3.7ppts		
Net Income to Parent	3,504	2,271	4,705	54.3%	-25.5%		
EPS (NT\$) <sup>(1)</sup>	3.71	2.40	4.98				
Cash Inflow Generated from Operations	13,248	5,143	15,458	157.6%	-14.3%		
Capital Expenditures	6,233	4,801	5,569	29.8%	11.9%		
Cash and Cash Equivalents <sup>(2)</sup>	65,970	59,979	48,957	10.0%	34.8%		
ROE(%) <sup>(3)</sup>	15.2%	10.0%	22.3%	+5.2ppts	-7.1ppts		

Note : (1) Weighted Average Shares outstanding as of 2023 : 944,956 thousand shares (Issued capital was 947,049 thousand shares within treasury shares 2,093 thousand) (2) Including current financial assets at amortized cost (time deposits, etc.) (3) Property, Plant and Equipment includes investment property (4) PPE Turnover = annualized net revenue / average net property, plant and equipment



## **2023 Financial Results**

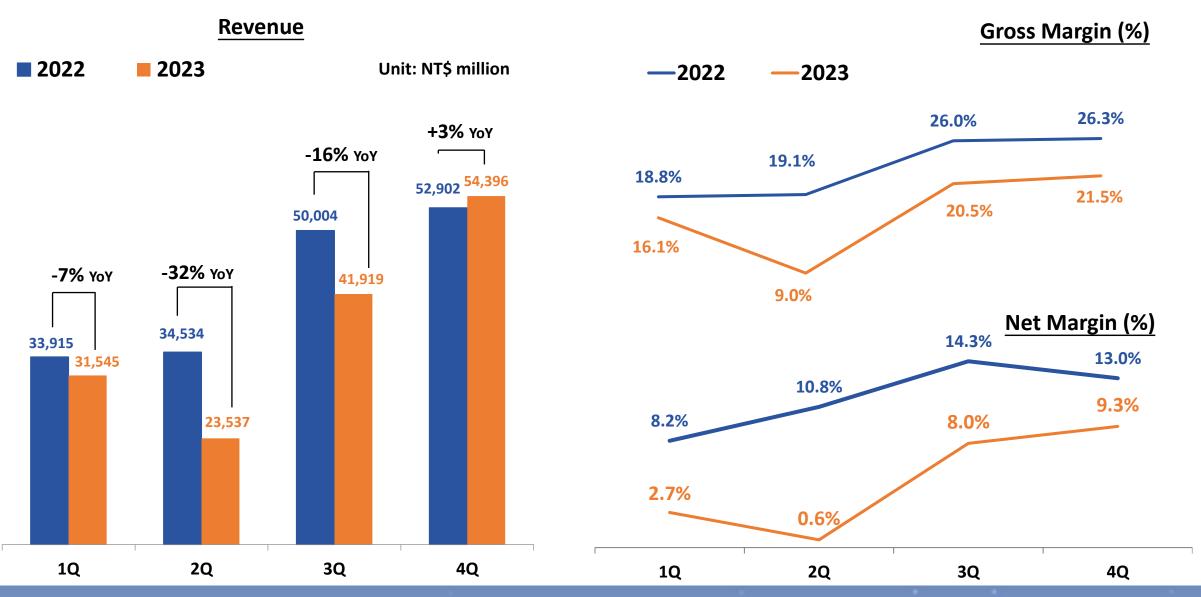
(Unit: NT\$ million, unless otherwise stated)

	2023	2022	YoY (%)
Revenue	151,398	171,356	-11.6%
Gross Profit	27,459	39,888	-31.2%
Gross Margin	18.1%	23.3%	-5.2ppts
Operating Expense	18,300	17,441	4.9%
Operating Profit	9,160	22,447	-59.2%
Operating Margin	6.1%	13.1%	-7.0ppts
Non-Operating Income/Expense	888	1,022	-13.1%
Net Income	9,432	20,535	-53.8%
Net Margin	6.2%	12.0%	-5.8ppts
Net Income to Parent	6,189	14,197	-56.4%
EPS (NT\$) <sup>(1)</sup>	6.55	15.02	
Cash Inflow Generated from Operations	33,608	45,311	-25.8%
Capital Expenditures	26,066	29,032	-10.2%
Cash and Cash Equivalents <sup>(2)</sup>	65,970	57,599	14.5%
ROE(%) <sup>(3)</sup>	7.1%	16.7%	-9.6ppts

Note : (1) Weighted Average Shares outstanding as of 2023 : 944,956 thousand shares (Issued capital was 947,049 thousand shares within treasury shares 2,093 thousand) (2) Including current financial assets at amortized cost (time deposits, etc.) (3) Property, Plant and Equipment includes investment property (4) PPE Turnover = annualized net revenue / average net property, plant and equipment



## **Quarterly Operation Results**

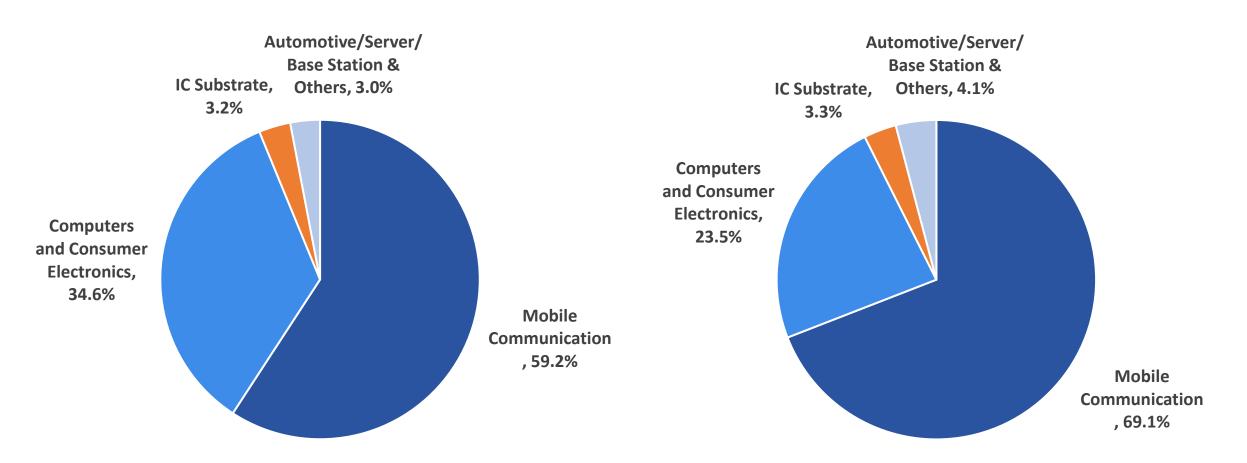




## **Revenue Breakdown – By Applications**



2023 Revenue NT\$151.4bn





## **Consolidated Balance Sheet and Key Indices**

	2023-12-	31	2022-12·	-31	Unit: NT\$ million Change		
-	Amount	%	Amount	%	Amount	%	
Cash and Cash Equivalents <sup>(2)</sup>	65,970	27.2%	57,599	24.8%	8,371	+2.4ppts	
Notes & Accounts Receivable	29,503	12.2%	30,529	13.1%	-1,026	-0.9ppts	
Inventories	15,508	6.4%	17,725	7.6%	-2,217	-1.2ppts	
Property, Plant and Equipment <sup>(3)</sup>	109,965	45.3%	104,814	45.1%	5,151	+0.2ppts	
Total Assets	242,932	100.0%	232,560	100.0%	10,372		
Debt	53,130	21.9%	45,359	19.5%	7,771	+2.4ppts	
Notes & Accounts Payable	37,853	15.6%	37,082	15.9%	771	-0.3ppts	
Total Liabilities	108,450	44.7%	99,694	42.9%	8,756		
Total Equity	134,326	55.3%	132,866	57.1%	1,460	-1.8ppts	
Key Indices							
A/R Turnover Days	72		72		-		
Inventory Turnover Days	52		52		-		
Current Ratio (x)	1.44		1.49		(0.05)		
PPE Turnover (x) <sup>(4)</sup>	1.47		1.84		(0.37)		

Note : (1) Weighted Average Shares outstanding as of 2023 : 944,956 thousand shares (Issued capital was 947,049 thousand shares within treasury shares 2,093 thousand) (2) Including current financial assets at amortized cost (time deposits, etc.) (3) Property, Plant and Equipment includes investment property (4) PPE Turnover = annualized net revenue / average net property, plant and equipment



## 2013-2023 Financial Summary

Unit: NT\$ million

Period	2013	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023
Revenue	64,483	75,954	85,738	82,393	109,238	117,913	120,068	131,279	155,022	171,356	151,398
Gross Profit	11,894	14,323	16,427	12,542	17,833	26,061	27,222	26,584	30,537	39,888	27,459
Net Income	5,471	6,735	7,731	3,456	6,772	11,536	12,402	11,508	13,694	20,535	9,432
Net Income to Parent	5,471	6,735	7,731	3,456	5,172	8,448	8,685	8,095	9,651	14,197	6,189
Depreciation & Amortization	3,742	4,293	4,850	5,295	5,679	6,820	7,955	8,405	11,875	14,638	16,323
EPS (NT\$)	7.41	9.12	9.80	4.29	6.43	10.50	9.93	8.90	10.21	15.02	6.550
DPS (NT\$)	3.00	3.67	4.50	2.20	3.30	4.46	4.50	4.50	5.00	6.00	3.275
Payout Ratio (%)	40.5%	40.2%	45.9%	51.3%	51.3%	42.5%	45.3%	50.6%	49.0%	40.0%	50.0%
Cash and Cash Equivalents*	10,016	23,482	31,572	30,241	33,296	49,154	43,071	46,775	35,179	57,599	65,970
Property, Plant and Equipment	27,843	30,073	32,074	32,262	36,681	41,913	46,243	68,177	86,073	104,814	109,965
Capital	7,386	7,386	8,047	8,047	8,047	8,047	9,022	9,470	9,470	9,470	9,470
ROE (%)	23.77%	23.33%	20.82%	8.59%	14.49%	17.30%	14.72%	11.84%	12.59%	16.67%	7.10%
Debt Ratio (%)	64.06%	62.54%	53.70%	59.72%	55.33%	44.25%	35.41%	42.56%	42.01%	42.87%	44.67%

\* Including current financial assets at amortized cost (time deposits, etc.)



Q&A

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